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Dated: April 30, 2007

Signature

Michelle Jacobson
(Michelle Jacobson)

Docket No.: 60803(49381)
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Kazuya Fujita et al.

Application No.: 10/773,809

Confirmation No.: 8452

Filed: February 5, 2004

Art Unit: 2814

For: SOLID STATE IMAGING DEVICE,
SEMICONDUCTOR WAFER, OPTICAL
DEVICE MODULE, METHOD OF SOLID
STATE IMAGING DEVICE FABRICATION,
AND METHOD OF OPTICAL DEVICE
MODULE FABRICATION

Examiner: W. S. Louie

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated January 31, 2007, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.